

Docket No.: 4459-140

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of :  
Inventors: Su TAO et al. :  
U.S. Patent Application No. *Not yet assigned* : Group Art Unit: *Not yet assigned*  
Filed: *Herewith* : Examiner: *Not yet assigned*  
For: SEMICONDUCTOR CHIP PACKAGE AND METHOD FOR MANUFACTURING  
THE SAME

**CLAIM OF PRIORITY**

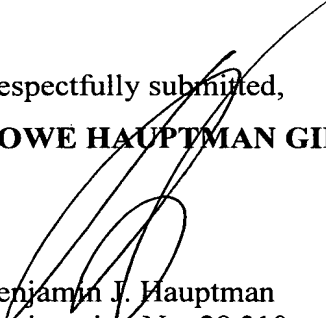
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In accordance with the provisions of 35 U.S.C. 119, Applicant hereby claims the priority of *Taiwanese Patent Application No. 092104882 filed March 5, 2003*. The certified copy will be filed in due course.

Respectfully submitted,

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**Date: March 4, 2004**